

**Marked-Up Copy of Substitute Specification**

**METHOD FOR PRODUCING COMPOSITE SOFT MAGNETIC MATERIAL HAVING  
HIGH STRENGTH AND HIGH SPECIFIC RESISTANCE**

CROSS-REFERENCE TO PRIOR RELATED APPLICATIONS

This application is a U.S. national phase application under  
35 U.S.C. §371 of International Patent Application No.  
PCT/JP2004/015983, filed October 28, 2004, and claims the  
benefit of Japanese Application No. 2003-370335, filed October  
30, 2003, both of which are incorporated by reference herein.  
The International Application was published in Japanese on May  
12, 2005 as International Publication No. WO 2005/043559 under  
PCT Article 21(2).

Technical Field

———{0001}

The present invention relates to: a method of producing a composite soft magnetic material having high strength and high specific resistance; and a composite soft magnetic material having high strength and high specific resistance, which is produced by the method. The method of producing the composite~~complex~~ soft magnetic material may be~~is~~ used for producing an injector part, an ignition part, an electronic valve core, and a motor core.

Background Art

~~-----{0002}~~

~~Among the materials generally known~~~~In general,~~ as soft magnetic powder, ~~are there is known~~ iron powder, Fe-Si iron-based soft magnetic alloy powder, Fe-Al iron-based soft magnetic alloy powder, Fe-Si-Al iron-based soft magnetic alloy powder, Fe-Cr iron-based soft magnetic alloy powder, Ni-based soft magnetic alloy powder, ~~and~~ Fe-Co iron-based soft magnetic alloy powder. The iron powder includes pure iron powder, the Fe-Si iron-based soft magnetic alloy powder includes Fe-Si iron-based soft magnetic alloy powder containing 0.1-10wt% of Si and the balance composed of Fe and necessary impurities, additives, or dopants (for example, ferrosilicon powder containing 1-12 % of Si and the balance composed of Fe and necessary impurities, and more particularly, Fe-3%Si powder), the Fe-Al iron-based soft magnetic alloy powder includes Fe-Al iron-based soft magnetic alloy powder containing 0.05-10 wt% of Al and the balance composed of Fe and necessary impurities (for example, Alperm powder having a composition of Fe-15%Al), the Fe-Si-Al iron-based soft magnetic alloy powder includes Fe-Si-Al iron-based soft magnetic alloy powder containing 0.1-10 wt% of Si, 0.05-10 wt% of Al and the balance composed of Fe and necessary impurities (for example, Sendust powder having a composition of

Fe-9%Si-5%Al), the Fe-Cr iron-based soft magnetic alloy powder includes Fe-Cr iron-based soft magnetic alloy powder containing 1-20 % of Cr, and if necessary, either one or both of 5 % or less of Al and 5% or less of Si, and the balance composed of Fe and necessary impurities, the Ni-based soft magnetic alloy powder includes Ni-based soft magnetic alloy powder containing 35~85% of Ni, and if necessary, one or two of 5% or less of Mo, 5% or less of Cu, 2% or less of Cr, and 0.5% or less of Mn, and the balance composed of Fe and necessary impurities (for example, Fe-79%Ni powder), and the Fe-Co iron-based soft magnetic alloy powder includes Fe-Co iron-based soft magnetic alloy powder containing 10-60 % of Co, and if necessary, 0.1-3% of V, and the balance composed of Fe and necessary impurities. ("wt%" means "wt%" for above.)

~~-----[0003]~~

An insulating film is formed on such soft magnetic powder to produce insulating film-coated soft magnetic powder and the insulating film-coated soft magnetic powder is hardened with resin to produce a composite soft magnetic material. As the insulating film-coated soft magnetic powder, there are known: oxide film-coated soft magnetic powder formed by performing high-temperature oxidation treatment on the soft magnetic powder to form an oxide film on the surface thereof; or phosphate film-coated soft magnetic powder formed by performing phosphate treatment on the soft magnetic material to form a phosphate film

on the surface thereof; ~~and hydroxylatedhydroxylation~~ film-coated soft magnetic powder formed by performing stream treatment on the soft magnetic powder to form an insulating ~~hydroxylatedhydroxylation~~ film on the surface thereof. Among these insulating film-coated soft magnetic powders, phosphate film-coated soft magnetic powder obtained by forming a phosphate film on the surface of pure iron powder is generally used.

~~-----{0004}~~

As a method of hardening the insulating film-coated soft magnetic powder with the resin to produce a composite soft magnetic material, there is a method of ~~placing~~filling mixture resin powder obtained by mixing 0.2-10 wt% of polyphenylenesulfide resin powder which is a thermoplastic compound having a particle diameter of 1 to 100  $\mu\text{m}$  and 0.05-1 wt% of stearic acid powder having a particle diameter of 1 to 100  $\mu\text{m}$  to the insulating film-coated soft magnetic powder in a mold which is heated to a temperature of 50 to 90 °C, compression-molding the mixture resin powder to produce a compact, curing the obtained compact at a temperature of 200 to 270 °C in a nitrogen atmosphere to remove the stearic acid, and further heating the compact at a temperature of 285 to 310 °C in a nitrogen atmosphere (see PCT Japanese Translation Patent Publication No. 2001-504283~~Patent Document 1~~).

~~-----{0005}~~

The method of hardening the insulating film-coated soft

magnetic powder with the resin to produce the composite soft magnetic material can provide an excellent composite soft magnetic material, because the polyphenylenesulfide resin has a high melting point and excellent heat resistance and has good heat resistance and insulation property even at under a high temperature~~temperature area~~. However, this method suffers from~~has~~ inferior moldability, because the polyphenylenesulfide resin powder has a melting point of at least 200 °C. To this end, there is suggested a method of adding 1-99% of polyamide resin powder to polyphenylenesulfide resin powder to produce mixture resin powder, compression-molding mixture powder obtained by adding ~~the~~ 0.1-3 wt% of the mixture resin powder to insulating film-coated soft magnetic powder to produce a compact, and curing the obtained compact at a temperature of 250 to 450 °C in a nitrogen atmosphere to produce a composite soft magnetic material (see ~~Patent Document 2~~).

~~Patent Document 1: PCT Japanese Translation Patent Publication No. 2001-504283~~

~~Japanese Unexamined Patent Application Publication No. 2003-183702).~~

Disclosure of the Invention

Problems to be Solved by the Invention

~~-----{0006}~~

However, the composite soft magnetic material produced by using mixture powder obtained by adding insulating film-coated soft magnetic powder to mixture resin powder composed of polyphenylenesulfide resin powder and the stearic acid or mixture resin powder composed of polyphenylenesulfide resin powder and polyamide resin powder need be cured at as high a temperature as possible, because sufficient transverse rupture strength cannot be obtained when the composite soft magnetic material is cured at a low temperature. However, when the composite soft magnetic material is cured at the high temperature in order to improve the transverse rupture strength, the specific resistance of the composite soft magnetic material is reduced.

#### Means for Solving the Problems

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Accordingly, the present inventors researched into a method of producing a composite soft magnetic material having high strength and high specific resistance and obtained the ~~researched~~ result that mixture powder having a composition containing 0.05-1 wt% of polyimide resin powder having an average particle diameter of 1 to 100  $\mu\text{m}$ , 0.002-0.1 wt% of fine amide-based wax powder having an average particle diameter of 1 to 20  $\mu\text{m}$ , and the balance composed of insulating film-coated soft

magnetic powder obtained by forming an insulating film on the surface of soft magnetic powder has good moldability, and a composite soft magnetic material obtained by heating the mixture powder at a temperature of 60 to 110 °C, filling the heated mixture powder in a mold which is heated at a temperature of 100 to 150 °C, compacting the heated mixture powder at a molding pressure of 700 to 1200 MPa to obtain a compact, and curing the obtained compact at a temperature of 225 to 300 °C has higher strength and higher specific resistance, in comparison with the conventional composite soft magnetic materials material.

~~-----[0003]~~

According to one ~~a first~~ aspect of the present invention, there is provided a method of producing a composite soft magnetic material having high strength and high specific resistance, including: heating mixture powder having a composition containing 0.05-1 wt% of polyimide resin powder having an average particle diameter of 1 to 100  $\mu\text{m}$ , 0.002-0.1 wt% of fine amide-based wax powder having an average particle diameter of 1 to 20  $\mu\text{m}$ , and the balance composed of insulating film-coated soft magnetic powder obtained by forming an insulating film on the surface of soft magnetic powder, at a temperature of 60 to 110 °C; filling the heated mixture powder in a mold which is heated at a temperature of 100 to 150 °C; compacting the heated mixture powder at a molding pressure of 700 to 1200 MPa to obtain a compact; and curing the obtained

compact at a temperature of 225 to 300 °C.

~~-----[0009]~~

As the insulating film-coated soft magnetic powder obtained by forming ~~an~~the insulating film on the surface of ~~the~~ soft magnetic powder, phosphate film-coated pure iron powder obtained by forming a phosphate film on the surface of pure iron powder may be~~is generally~~ used.

Thus, according~~According to another~~~~a second~~ aspect of the present invention, there is provided a method of producing a composite soft magnetic material having high strength and high specific resistance, including: heating mixture powder having a composition containing 0.05-1 wt% of polyimide resin powder having an average particle diameter of 1 to 100  $\mu\text{m}$ , 0.002-0.1 wt% of fine amide-based wax powder having an average particle diameter of 1 to 20  $\mu\text{m}$ , and the balance composed of phosphate film-coated iron powder obtained by forming a phosphate film on the surface of pure iron powder, at a temperature of 60 to 110 °C; filling the heated mixture powder in a mold which is heated at a temperature of 100 to 150 °C; compacting the heated mixture powder at a molding pressure of 700 to 1200 MPa to obtain a compact; and curing the obtained compact at a temperature of 225 to 300 °C.

Effect of the Invention

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The present invention enables one~~It is possible~~ to produce a composite soft magnetic material having higher strength and higher specific resistance, in comparison with ~~the~~ conventional composite soft magnetic materials~~material~~.

~~-----{0011}~~

As the polyimide resin powder contained in the mixture powder used for the method of producing the composite soft magnetic material according to the present invention, wholly aromatic polyimide resin powder, bismaleide~~bismaleide~~-based polyimide resin powder, or additive polyimide resin powder may be used and the average particle diameter thereof is preferably in a range of 1 to 100  $\mu\text{m}$  (preferably 10 to 80  $\mu\text{m}$ , and more preferably 10 to 50  $\mu\text{m}$ ). This is because it is difficult to produce polyimide resin powder having an average particle diameter of 1  $\mu\text{m}$  or less and it is impossible to obtain sufficient strength and high specific resistance when the polyimide resin powder~~power~~ having an average particle diameter of 100  $\mu\text{m}$  or more is used. In addition, the amount of the polyimide resin powder contained in the mixture powder is preferably in a range of 0.05 to 1 wt% (more preferably 0.1 to 0.5 wt%). This is because sufficient specific resistance cannot be ensured when the amount of the polyimide resin powder contained in the mixture powder is less than 0.05 wt% and density, flux density, and magnetic permeability are reduced

when the amount of the polyimide resin powder is greater than 1 wt%.

In addition to the polyimide resin powder, 0.002-0.1 wt% (preferably, 0.004-0.05 wt%) of fine amide-based wax powder having an average particle diameter of 1 to 20  $\mu\text{m}$  (preferably, 1 to 10  $\mu\text{m}$ ) need be added to the mixture powder as lubricant. As the amide-based wax, simple substance of ~~ethylenebisstearoamide~~ethylenebisstearoidamide, ethylenebislauramide, or methylenebisstearoid, or a mixture thereof may be used.

By adding the amide-based wax powder together with the polyimide resin powder, filling property of the polyimide resin is improved to suppress generation of a large triple point and crescent tear due to extrusion of resin to the triple point is prevented from occurring in the powder grain boundary, thereby ~~due to extrusion of resin to the triple point to~~ increasing~~increase~~ the density of the compact. However, when the amount of the amide-based wax powder contained in the mixture powder is less than 0.002 wt%, sufficient flow property cannot be ensured, and, when the amount of the amide-based wax powder contained in the mixture powder is greater than 0.1 wt%, the strength of the composite soft magnetic material is reduced.\_\_\_\_  
-----Accordingly, the amount of the amide-based wax powder contained in the mixture powder is chosen to be~~determined to~~ 0.002 to 0.1 wt%.

-----The average particle diameter of the amide-based wax powder added to the mixture powder is preferably in a range of 1 to 20  $\mu\text{m}$ . This is because it is difficult to produce amide-based wax powder having an average particle diameter of 1  $\mu\text{m}$  or less and because the amount of the added material necessary for ensuring the flow property ~~too~~ increases too much to achieveand sufficient strength ~~cannot be obtained~~ when amide-based powder having an average particle diameter of 20  $\mu\text{m}$  or more is used.

The mixture powder having such a composition is heated at a temperature of 60 to 110 °C, and filled and compression-molded in a mold which is heated at a temperature of 100 to 150 °C. The reason why the mold is heated at the temperature of 100 to 150 °C is because, when colloidal lubricant agent is coated on a wall surface of the mold, moisture contained in the lubricant agent is evaporated and the solid lubricant agent is attached to the wall surface of the mold. Accordingly, the heating temperature of the mold need be 100 °C or more, but need not be 150 °C or more. When the heating temperature of the mixture powder filled in the heated mold is less than 60 °C, the density of the compact does not increase, and, when the heating temperature of the mixture powder is greater than 110 °C, the flow property is reduced. Accordingly, the mixture powder filled in the mold is heated at the temperature of 60 to 110 °C.

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The reason why ~~the~~ mixture powder filled in the mold is

compression-molded at the pressure of 700 to 1200 MPa is because, when the compression molding pressure is less than 700 MPa, sufficient density cannot be obtained, and, when the compression molding pressure is greater than 1200 MPa, the specific resistance is reduced. The compact obtained by the compression molding is cured at a temperature of 225 to 300 °C for 30 to 60 minutes. By curing at the above-described temperature, a composite soft magnetic material having high strength and high specific resistance is obtained. In addition, by curing at the above-described temperature, distortion of the soft magnetic powder is removed and soft magnetic property is restored. The reason why the curing temperature is limited to 225 to 300 °C is because the resin is insufficiently hardened when the curing temperature is less than 225 °C and the strength and the specific resistance are reduced due to the decomposition of the resin when the curing temperature is greater than 300 °C.

According to ~~this~~the method of producing the composite soft magnetic material using the polyimide resin powder, it is possible to produce a composite soft magnetic material having higher strength and higher specific resistance, in comparison with ~~the~~ conventional composite soft magnetic ~~materials~~material ~~produced by using the~~ polyphenylenesulfide resin powder. This is because ~~the~~ polyphenylenesulfide resin has inferior distortion property and thus damages the insulating film of the insulating film-coated soft magnetic powder at the time of compression-

molding at 700 to 1200 MPa, leading to reduced~~reduce the~~ specific resistance. Meanwhile, when the ratio of the polyamide resin is large, the polyamide resin is too soft and thus crescent tear of the insulating film generated between grains of the insulating film-coated soft magnetic powder ~~and the insulating film-coated soft magnetic powder occurs~~, thereby reducing the specific resistance.

Best Mode for Carrying out the Invention

~~-----{0013}~~

Embodiment

As a raw material, ~~available~~ phosphate film-coated iron powder having an average particle diameter of 80  $\mu\text{m}$ , which is -- obtained by performing phosphate treatment on pure iron powder to form a phosphate film on the surface thereof, was prepared and additive polyimide resin powder and ethylenebisstearoamide~~ethylenebisstearoidamide~~ powder having average particle diameters shown in Table 1 were prepared. By adding and mixing the additive polyimide resin powder and the ethylenebisstearoamide~~ethylenebisstearoidamide~~ powder to the phosphate film-coated iron powder with ratiosa~~ratio~~ shown in Table 1 in ambient~~the~~ atmosphere, mixture powders A to R of compositions shown in Table 1 were produced.

~~{0014}~~

Table 1

Type		Composition (wt%)				
		Additive polyimide resin powder		Ethylenebis-stearamide powder		Phosphate film-coated iron powder
		Average particle diameter ( $\mu\text{m}$ )		Average particle diameter ( $\mu\text{m}$ )		
Mixture powder	A	40	0.2	5	0.01	Balance
	B	40	0.05	5	0.01	Balance
	C	40	0.1	5	0.01	Balance
	D	40	0.4	5	0.01	Balance
	E	40	0.6	5	0.01	Balance
	F	40	0.8	5	0.01	Balance
	G	20	0.2	10	0.004	Balance
	H	20	0.2	10	0.008	Balance
	I	20	0.25	10	0.02	Balance
	J	20	0.25	10	0.04	Balance
	K	80	0.25	10	0.06	Balance
	L	80	0.25	10	0.09	Balance
	M	40	1.1*	5	0.01	Balance
	N	80	0.04*	10	0.01	Balance
	O	105*	0.1	5	0.01	Balance
	P	40	0.2	10	0.12*	Balance
	Q	40	0.2	10	0.0015*	Balance
	R	40	0.2	22*	0.01	Balance

Symbol \* shows a value out of a range of the present invention.

~~-----{0015}~~

The mixture powders A to R were heated at temperatures shown in Tables 2 and 3. In addition, an aqueous solution

including 1% of sodium benzoate and 1% of dipotassium hydrogen phosphate was sprayed and dried on a wall surface of a mold which ~~was~~ heated at temperatures shown in Tables 2 and 3, the heated mixture powders A to R were filled in the mold which ~~was~~ heated at ~~temperatures~~~~the temperature~~ shown in Tables 2 and 3 and compression-molded with pressures shown in Tables 2 and 3 to produce a compact, and the compact was heated for a time shown in Tables 2 and 3 at the temperature shown in Table 2 and 3 in ~~ambient~~~~the~~ atmosphere, ~~the various combinations of conditions represented by~~~~thereby performing~~ Present methods 1 to 12 and Comparative methods 1 to 13 in the Tables. Accordingly composite soft magnetic samples having a size of 5 mm × 10 mm × 60 mm were produced.

The transverse rupture strength, the density, the specific resistance, and the flux density of the composite soft magnetic samples were measured at a room temperature and the measured results ~~are~~~~were~~ shown in ~~Tables~~~~Table~~ 2 and 3.

~~-----[0016]~~

#### Conventional Example

Mixture powder obtained by adding and mixing 1 wt% of polyphenylenesulfide resin powder having an average particle diameter of 30  $\mu\text{m}$  and 0.2 wt% of stearic acid powder having an average particle diameter of 30  $\mu\text{m}$  to the insulating film-coated iron powder prepared in the embodiment above was filled in a

mold which ~~was~~ heated at a temperature of 70 °C and was compression-molded to produce a compact, the obtained compact was cured at a temperature of 230 °C in a nitrogen atmosphere to remove stearic acid, and the compact was heated at a temperature of 300 °C in a nitrogen atmosphere, ~~giving thereby performing~~ Conventional method 1 in the Tables.

~~-----{0017}~~

In addition, mixture resin powder ~~was produced~~ obtained by ~~adding and mixing~~ 50 wt% of polyphenylenesulfide resin powder having an average particle diameter of 18  $\mu\text{m}$  and 50 wt% of polyamide resin powder ~~to the phosphate film-coated iron powder prepared in the embodiment was produced~~, 1.5 wt% of this mixture resin powder was mixed with the phosphate film-coated iron powder prepared in the embodiment above to produce mixture powder, the obtained mixture powder was compression-molded to produce a compact, and the obtained compact was cured at a temperature of 300 °C in a nitrogen atmosphere to produce a composite soft magnetic sample, ~~giving thereby performing~~ Conventional method 2 in the Tables.

~~-----~~ The transverse rupture strength, the density, the specific resistance, and the flux density of the composite soft magnetic samples obtained by Conventional methods 1 and 2 were measured at ~~a~~ room temperature and the measured results ~~are~~ were shown in ~~Tables~~ Table 2 and 3.

Table 2

Type	Mixture powder of Table 1	Production condition				Property of soft magnetic sample					
		Heating temperature of mixture powder (°C)	Heating temperature of mold (°C)	Compression molding pressure (MPa)	Curing temperature (°C)	Curing time (minute)	Transverse rupture strength (MPa)	Density (Kg/m <sup>3</sup> )	Specific resistance 10 <sup>-4</sup> (Ω.m)	Flux density B <sub>10000Am</sub> (T)	
Present method	1	A	90	120	800	250	30	140	7.5	3.6	1.58
	2	B	60	120	800			132	7.55	1.1	1.60
	3	C	80	120	800			140	7.53	2.7	1.59
	4	D	100	120	800			125	7.40	5.3	1.53
	5	E	110	120	800			125	7.33	8.1	1.50
	6	F	100	100	800			118	7.25	12	1.46
	7	G	100	130	800			135	7.61	3.4	1.56
	8	H	100	150	800			130	7.52	2.9	1.57
	9	I	100	120	1200			146	7.59	1.8	1.61
	10	J	100	120	1000			142	7.56	2.2	1.60
	11	K	100	120	770			130	7.44	3.8	1.55
	12	L	100	120	730			127	7.40	4.0	1.52
	1	M	100	120	800	82	7.09	52	1.35		
	2	N	100	120	800	118	7.53	0.58	1.57		

Table 3

Type	Mixture powder of Table 1	Production condition				Property of soft magnetic sample						
		Heating temperature of mixture powder (°C)	Heating temperature of mold (°C)	Compression molding pressure (MPa)	Curing temperature (°C)	Curing time (minute)	Transverse rupture strength (MPa)	Density (Kg/m <sup>3</sup> )	Specific resistance ×10 <sup>-4</sup> (Ωm)	Flux density B <sub>1000G-m</sub> (T)		
Comparative method	3	0	100	120	800	250	30	97	7.50	0.65	1.58	
	4	P	100	120	800	250		63	7.41	4.2	1.53	
	5	Q	100	120	800	250		110	7.48	0.92	1.56	
	6	R	100	120	800	250		92	7.47	0.88	1.55	
	7	A	115*	120	800	250		85	7.38	0.78	1.52	
	8	A	55*	120	800	250		98	7.40	1.0	1.51	
	9	A	100	160*	800	250		111	7.50	0.61	1.57	
	10	A	100	90*	800	250		87	7.38	2.1	1.51	
	11	A	100	120	1300*	250		132	7.63	0.72	1.63	
	12	A	100	120	650	250		80	7.36	4.2	1.51	
	13	A	10	120	800	320*		75	7.50	0.65	1.58	
	14	A	100	120	800	320*		83	7.50	4.2	1.57	
	Conventional method	1	-					120	7.03	3.8	1.31	
	2	-						115	6.92	8.5	1.25	

Symbol \* shows a value out of a range of the present invention.

From the results shown in ~~Tables~~Table 2 and 3, it can be seen that the soft magnetic samples produced by Present methods 1 to 12 have superior~~more excellent~~ soft magnetic properties~~property~~, compared with the soft magnetic samples produced by Conventional methods 1 ~~and~~to 2. In addition, the soft magnetic samples produced by Comparative methods 1 to 14 performed under conditions~~a condition~~ different from those~~that~~ of the present invention have ~~partially have~~ inferior properties~~property~~.